



# CEC-ICMC 2019 - Abstracts, Timetable and Presentations

## Wednesday, July 24, 2019

### M3Or1B - Microelectronics I - Level 6, Room 14 (9:30 AM - 11:00 AM)

-Conveners: Vyacheslav Solovyov; Thomas Bullard

time	[id] title	presenter
9:30 AM	M149] M3Or1B-01 [Invited]: Recent Progress on Flexible Superconducting Integration Technology: Cables and Connectors	Dr HAMILTON, Michael
10:00 AM	M148] M3Or1B-02 [Invited]: Planar MgB2 Josephson junctions and arrays made by focused helium ion beam	Prof. CHEN, Ke
10:30 AM	M186] M3Or1B-03 [Invited]: REBCO Tapes on Flexible Dielectric Substrates as Transmission Lines for High Frequency Applications	SELVAMANICKAM, Venkat